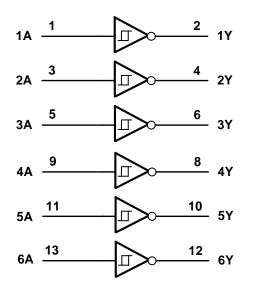


## **Pin Descriptions**

Pin Number	Pin Name	Description
1	1A	Data Input
2	1Y	Data Output
3	2A	Data Input
4	2Y	Data Output
5	ЗA	Data Input
6	3Y	Data Output
7	GND	Ground
8	4Y	Data Output
9	4A	Data Input
10	5Y	Data Output
11	5A	Data Input
12	6Y	Data Output
13	6A	Data Input
14	V <sub>CC</sub>	Supply Voltage

## Logic Diagram



# **Function Table**

Inputs	Outputs	
Α	Y	
Н	L	
L	Н	



Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V <sub>CC</sub>	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or IOFF state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V <sub>CC</sub> +0.5	V
I <sub>IK</sub>	Input Clamp Current V <sub>1</sub> < 0	-50	mA
I <sub>OK</sub>	Output Clamp Current V <sub>O</sub> < 0	-50	mA
Ι <sub>Ο</sub>	Continuous output current	50	mA
	Continuous current through V <sub>DD</sub> or GND	±100	mA
T <sub>J</sub> Operating Junction Temperature		-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
P <sub>TOT</sub> Total Power Dissipation		500	mW

### Absolute Maximum Ratings (Note 4) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

# Recommended Operating Conditions (Note 5) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		1.65	5.5	V
VI	Input Voltage		0	5.5	V
M		Active Mode	0	V <sub>CC</sub>	V
Vo	Output Voltage	V <sub>CC</sub> = 0V; Power Down Mode	0	5.5	V
TA	Operating free-air temperature		-40	+125	٥C

Note: 5. Unused inputs should be held at V<sub>CC</sub> or Ground.



# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

<b>.</b>		Tako katiki		T <sub>A</sub> = -40°C	to +85°C	T <sub>A</sub> = -40°C	to +125°C	
Symbol	Parameter	Test Conditions	Vcc	Min	Max	Min	Max	Unit
			2.5V	0.9	1.7	0.9	1.7	
$V_{T+}$	Positive Going	-	2.7V	1.1	2.0	1.1	2.0	V
	Threshold		2.7V to 3.6V	1.1	2.0	1.1	2.0	
			2.5V	0.4	1.2	0.4	1.2	
V <sub>T</sub> .	Negative Going Threshold		2.7V	0.8	1.5	0.8	1.5	V
	Threshold		2.7V to 3.6V	0.8	1.5	0.8	1.5	
			2.5V	0.3		0.2		
Vн	Hysteresis (V <sub>T+ -</sub> V <sub>T-)</sub>		2.7V	0.3		0.3		
	(VT+-VT-)		2.7V to 3.6V	0.3		0.3		
		Ι <sub>ΟΗ</sub> = -100μΑ	1.65V to 3.6V	$V_{CC} - 0.2$		V <sub>CC</sub> -0.3		
		I <sub>OH</sub> = -4mA	1.65V	1.2				
.,	High Level	I <sub>OH</sub> = -8mA	2.3V	1.9				.,
V <sub>OH</sub>	Output Voltage		2.7V	2.2		2.05		V
		I <sub>OH</sub> = -12mA	3.0V	2.3		2.1		
		I <sub>OH</sub> = -24mA	3.0V	2.2		2.0		
		I <sub>OH</sub> = 100μA	1.65V to 5.5V		0.2		0.3	
		I <sub>OH</sub> = 4mA	1.65V		0.45		0.6	
V	High-level	I <sub>OH</sub> = 8mA	2.3V		0.70		0.85	Ň
V <sub>OL</sub>	Output Voltage	40	2.7V		0.40		0.6	V
		I <sub>OH</sub> = 12mA	3.0V		0.55		0.6	
		I <sub>OH</sub> =-24 mA	3.0V		0.55		0.6	
l <sub>l</sub>	Input Current	V <sub>I</sub> =GND to 5.5V	3.6V		± 5		± 20	μA
IOFF	Power Down Leakage Current	$V_1 \text{ or } V_0 = 0V \text{ to } 3.6V$	0		10		20	μA
I <sub>CC</sub>	Supply Current	$V_I = GND \text{ or}$ $V_{CC} I_O=0$	3.6V		10		40	μA
ΔI <sub>CC</sub>	Additional Supply Current	One input at V <sub>CC</sub> –0.6 V Other	2.7V to 3.6V		500		5000	μA



# **Switching Characteristics**

Symbol	Parameter	Test	V	T,	₄ = +25°	°C	-40°C to	o +85°C	-40°C to	+125°C	Unit
Symbol	Parameter	Conditions	V <sub>cc</sub>	Min	Тур	Max	Min	Max	Min	Max	Unit
			1.65V to1.95V	0.5	4.1	8.9	0.5	8.9	0.5	9.5	
	Propagation	Figure 1	2.3V to 2.7V	0.5	3.6	7.0	0.5	7.5	0.5	9.0	
t <sub>PD</sub>	Delay $A_{\text{N}}$ to $Y_{\text{N}}$	Figure 1	2.7V	0.5	3.0	5.3	0.5	5.5	0.5	7.0	ns
			3V to 3.6V	0.5	2.5	4.8	0.5	4.8	0.5	6.0	
t <sub>SK(0)</sub>	Output Skew Time		3V to 3.6V					1.0		1.5	ns

# Operating Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V <sub>CC</sub> = 1.8V Typ	V <sub>cc</sub> = 2.5V Typ	V <sub>CC</sub> = 3.3V Typ	V <sub>cc</sub> = 5V Typ	Unit
C <sub>pd</sub>	Power dissipation capacitance per gate	f = 10MHz	7.0	7.5	8.0	8.6	pF
CI	Input Capacitance	V <sub>i</sub> = V <sub>CC</sub> – or GND	4	4	4	4	pF

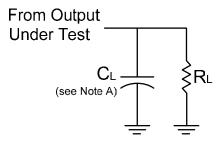
# **Package Characteristics**

Symbol	Parameter	Test Conditions	V <sub>cc</sub>	Min	Тур	Max	Unit
0	Thermal Resistance	SO-14			TBD		°C/W
θ <sub>JA</sub>	Junction-to-Ambient	TSSOP-14	(Note 6)		159		
0	Thermal Resistance	SO-14	(Nata C)		TBD		°C/W
θ <sub>JC</sub>	Junction-to-Case	TSSOP-14	(Note 6)		25		C/W

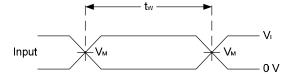
Note: 6. Test condition for SO-14 and TSSOP-14: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



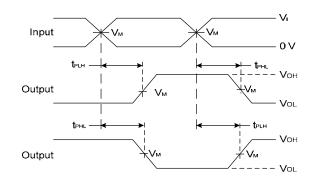
#### **Parameter Measuement Information**



V	Inputs		V	C	в	
V <sub>cc</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	CL	RL	
1.8V±0.15V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	30pF	1ΚΩ	
2.5V±0.2V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	30pF	500Ω	
3.3V±0.3V	3V	≤2.5ns	1.5V	50pF	500Ω	
5V±0.5V	V <sub>CC</sub>	≤2.5ns	V <sub>CC</sub> /2	50pF	500Ω	



Voltage Waveform Pulse Duration



#### Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

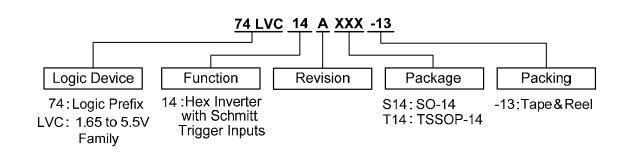
Notes: A . Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
- C. Inputs are measured separately one transition per measurement
- D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{PD}$

#### Figure 1. Load Circuit and Voltage Waveforms



### **Ordering Information**

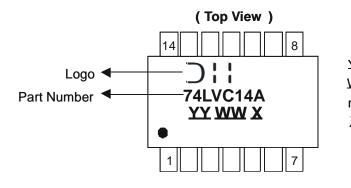


	Device	Package Packaging		13" Tape and Reel		
	Device	Code	(Note 7)	Quantity	Part Number Suffix	
<b>Pb</b> ,	74LVC14AS14-13	S14	SO-14	2500/Tape & Reel	-13	
PD,	74LVC14AT14-13	T14	TSSOP-14	2500/Tape & Reel	-13	

Notes: 7. The taping orientation and tape details can be found at http://www.diodes.com/datasheets/ap02007.pdf

## **Marking Information**

#### (1) SO-14, TSSOP-14



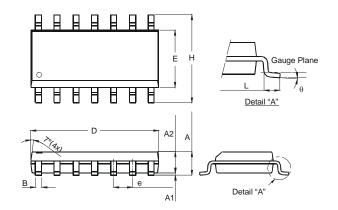
YY : Year : 08, 09,10~ WW : Week : 01~52; 52 represents 52 and 53 week Δ : Internal Code

Part Number	Package
74LVC14AS14	SO-14
74LVC14AT14	TSSOP-14



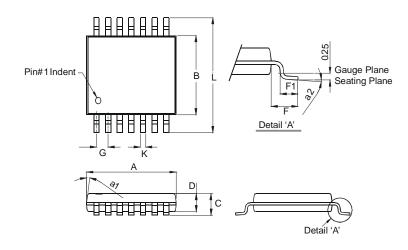
## Package Outline Dimensions (All dimensions in mm.)

#### Package Type: SO-14



	SO-14	
Dim	Min	Max
Α	1.47	1.73
A1	0.10	0.25
A2	1.45	Тур
В	0.33	0.51
D	8.53	8.74
Е	3.80	3.99
е	1.27	Тур
н	5.80	6.20
L	0.38	1.27
θ	0°	8°
All Di	mensions	s in mm

### Package Type: TSSOP-14



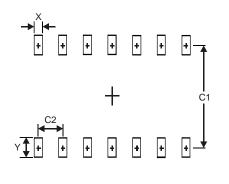
TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
Α	4.9	5.10
В	4.30	4.50
С		1.2
D	0.8	1.05
F	1.00 Typ	
F1	0.45	0.75
G	0.65 Тур	
κ	0.19	0.30
L	6.40 Тур	
All Dimensions in mm		



74LVC14A

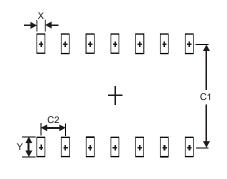
## **Suggested Pad Layout**

#### Package Type: SO-14



Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65



#### **IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2012, Diodes Incorporated

www.diodes.com